

# **STTH112**

### High voltage ultrafast rectifier

#### **Features**

- Low forwarded voltage drop
- High reliability
- High surge current capability
- Soft switching for reduced EMI disturbances
- Planar technology

### **Description**

The STTH112, which is using ST ultrafast high voltage planar technology, is specially suited for free-wheeling, clamping, snubbering, demagnetization in power supplies and other power switching applications

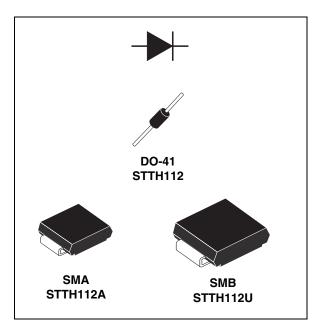


Table 1. Device summary

Symbol	Value
I <sub>F(AV)</sub>	1 A
$V_{RRM}$	1200 V
T <sub>j (max)</sub>	175 °C
V <sub>F (max)</sub>	1.65 V

### 1 Electrical characteristics

### **Absolute ratings (limiting values)**

Symbol	Parameter		Value	Unit		
$V_{RRM}$	Repetitive peak reverse voltage				1200	V
V <sub>(RMS)</sub>	Voltage rms				850	V
		TI = 85°C	δ =0.5	DO-41		
I <sub>F(AV)</sub>	I <sub>F(AV)</sub> Average forward current		δ =0.5	SMA	1	Α
		TI = 125°C	δ =0.5	SMB		
				DO-41	20	
I <sub>FSM</sub>	Forward surge current t = 8.3 ms		SMA	- 18	Α	
				SMB	10	
T <sub>stg</sub>	Storage temperature range				- 50 + 175	°C
T <sub>j</sub>	Maximum operating junction temperature				+ 175	°C

#### Table 2. Thermal parameters

Symbol	Parameter			Value	Unit
		L = 10 mm	DO-41	45	
R <sub>th (j-l)</sub>	Junction to lead		SMA	30	°C/W
			SMB	25	C/VV
R <sub>th (j-a)</sub>	Junction to ambient	L = 10 mm	DO-41	110	

#### Table 3. Static electrical characteristics

Symbol	Parameter	Tests conditions		Min.	Тур.	Max.	Unit
ı	Reverse leakage current	rse leakage current $V_R = 1200 \text{ V}$				5	۸
'R	I <sub>R</sub> Heverse leakage current		T <sub>j</sub> = 125 °C			50	μΑ
			T <sub>j</sub> = 25 °C			1.9	
$V_{F}$	V <sub>F</sub> Forward voltage drop		T <sub>j</sub> = 125 °C		1.17	1.65	V
			T <sub>j</sub> = 150 °C		1.10	1.55	

### Table 4. Dynamic electrical characteristics

Symbol	Parameter	Tests conditions		Min.	Тур.	Max.	Unit
t <sub>rr</sub>	Reverse recovery time	$I_F = 0.5 A$ $I_{rr} = 0.25 A I_R = 1A$	T <sub>j</sub> = 25 °C			75	ns
t <sub>fr</sub>	Forward recovery time	I <sub>F</sub> = 1 A	T 05.00			500	ns
V <sub>FP</sub>	Forward recovery voltage	$dI_F/dt = 50 A/\mu s$ $V_{FR} = 1.1 x V_{Fmax}$	T <sub>j</sub> = 25 °C			30	V

Figure 1. Conduction losses versus average Figure 2. Forward voltage drop versus current forward current

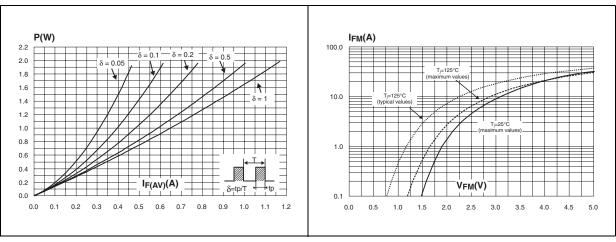


Figure 3. Relative variation of thermal impedance junction ambient versus pulse duration (DO-41)

Figure 4. Relative variation of thermal impedance junction ambient versus pulse duration (epoxy FR4) (SMA)

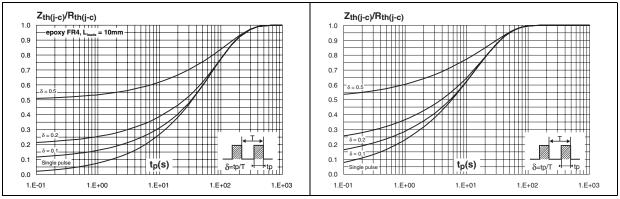
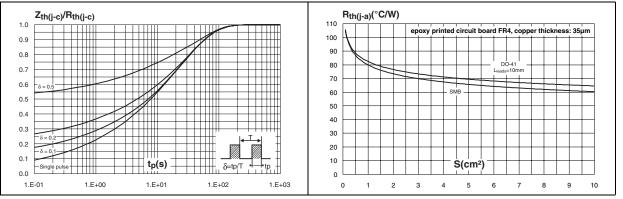


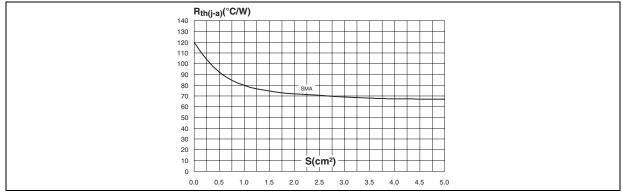
Figure 5. Relative variation of thermal impedance junction ambient versus pulse duration (epoxy FR4)(SMB)

Figure 6. Thermal resistance junction to ambient versus copper surface under each lead (DO-41, SMB)



Electrical characteristics STTH112

Figure 7. Thermal resistance junction to ambient versus copper surface under each lead (epoxy printed circuit board FR4, copper thickness: 35µm) (SMA)



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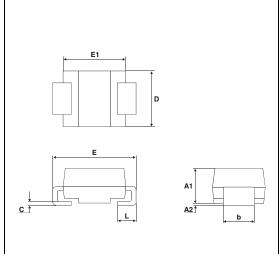
STTH112 Package information

### 2 Package information

- Epoxy meets UL 94, V0
- Band indicates cathode
- Bending method (DO-41): see Application note AN1471

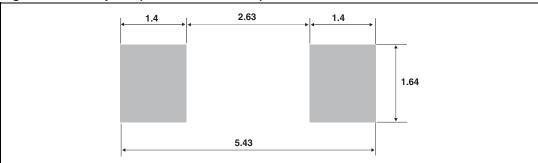
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

Table 5. SMA dimensions



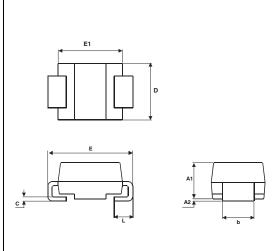
	Dimensions					
Ref.	Millimeters		Inc	hes		
	Min.	Max.	Min.	Max.		
A1	1.90	2.45	0.075	0.094		
A2	0.05	0.20	0.002	0.008		
b	1.25	1.65	0.049	0.065		
С	0.15	0.40	0.006	0.016		
D	2.25	2.90	0.089	0.114		
Е	4.80	5.35	0.189	0.211		
E1	3.95	4.60	0.156	0.181		
L	0.75	1.50	0.030	0.059		

Figure 8. Footprint (dimensions in mm)



Package information STTH112

Table 6. SMB dimensions



	Dimensions					
Ref.	Millimeters		Inc	hes		
	Min.	Max.	Min.	Max.		
A1	1.90	2.45	0.075	0.096		
A2	0.05	0.20	0.002	0.008		
b	1.95	2.20	0.077	0.087		
С	0.15	0.40	0.006	0.016		
D	3.30	3.95	0.130	0.156		
Е	5.10	5.60	0.201	0.220		
E1	4.05	4.60	0.159	0.181		
L	0.75	1.50	0.030	0.059		

Figure 9. Footprint (dimensions in mm)

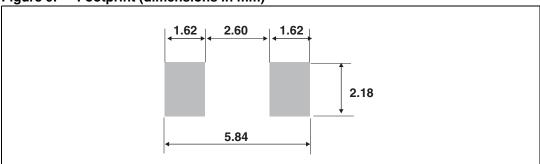
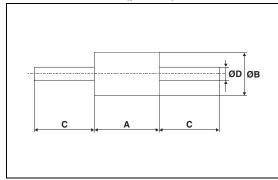


Table 7. DO-41 (plastic) dimensions



	Dimensions					
Ref.	Millimeters		Inc	hes		
	Min.	Max.	Min.	Max.		
Α	4.07	5.20	0.160	0.205		
В	2.04	2.71	0.080	0.107		
С	25.4		1			
D	0.71	0.86	0.028	0.034		

# 3 Ordering information

Table 8. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery Mode
STTH112	STTH112	DO-41	0.34 g	2000	Ammopack
STTH112A	H12	SMA	0.068 g	5000	Tape and reel
STTH112U	U12	SMB	0.11 g	2500	Tape and reel
STTH112RL	STTH112	DO-41	0.34 g	5000	Tape and reel

# 4 Revision history

Table 9. Document revision history

Date	Revision	Changes
Jan-2003	2	Initial release.
22-Jun-2005	3	New value of $T_j$ = 150 °C added to table 2. Dimensions A1 E and D updated in Table 4. Data sheet reformatted. No other technical changes.
20-Mar-2007	4	Reformatted to current standards. Updated dimensions and footprints for SMA and SMB packages.
30-Sep-2009	5	Updated table 7 package dimensions.

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